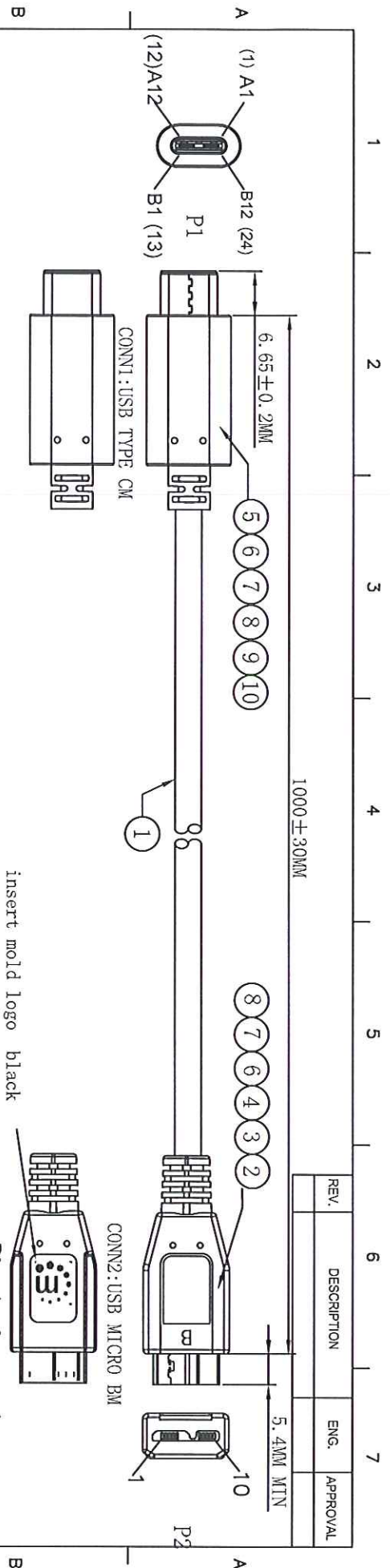
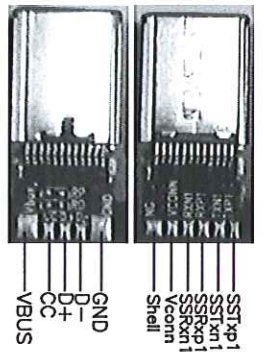


REV.	DESCRIPTION	ENG.	APPROVAL



Electrical Test:

1. 100% Test (Open, short, miss wire)
2. Contact Resistance: 2 ohm max.
3. Insulation Resistance: 100M ohm Min.
4. Hi-Pot: 300VDC/10ms.
5. USB MICRO BM: insert mold logo "m"



ok.  
Allen L  
2015.12.3

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INTRACOM Asia Co., LTD.

NO.	DESCRIPTION	QTY	UNIT
1	USE TYPE C CONNECTOR TYPE: IN DRAWING (REFER TO OTHER DRAWING SHEET)	1	pcs
2	USE TYPE C CONNECTOR TYPE: IN DRAWING (REFER TO OTHER DRAWING SHEET)	1	pcs
3	H.S.T. #2.5 BLACK	1	pcs
4	USE 3.1 C TYPE MINI CONNECTOR (REFER DRAWING SHEET WITH PART NUMBER/DESCRIPTION)	16	g
5	Outside Molding 4SP PVC PMS:BLACK	4	g
6	Inside Molding: PE	1	Set
7	USB 3.0 Micro (BM) SOLDER INSULATION:BLACK SHELL NICKEL PLATED	1	Set
8	USB 3.0 Micro (BM) FRONT SHELL NICKEL PLATED SHELL	1	Set
9	USB 3.0 Micro (BM) BACK SHELL NICKEL PLATED SHELL	1.0	m

TOLERANCE (INCH)	TOLERANCE (MM)
X.X	±0.02"
X.X	±0.01"
X.XX	±0.008"
X.XXX	±0.005"

TITLE:	MH USB3.1Gen2 Cbl CM-MicroBM_3A:Black_3fr/1m
CUSTOMER:	Customer P/N: 353397
APPD	Check
Unit	mm
Scale	1:1
Projection	1st Angle
Size	A4
Sheet	1 of 2
REV.	A06

THIS DRAWING MAY BE USED IN WHOLE OR PART